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FFSD10120A

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

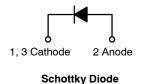
Features

- Max Junction Temperature 175°C
- Avalanche Rated 100 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- This Device is Pb–Free, Halogen Free/BFR Free and RoHS Compliant

Applications

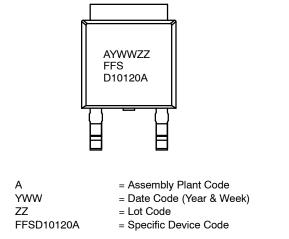
- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits







MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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Symbol	Parameter	Value	Unit	
V _{RRM}	Peak Repetitive Reverse Voltage	1200	V	
E _{AS}	Single Pulse Avalanche Energy (Note 1)	100	mJ	
١ _F	Continuous Rectified Forward Current @ T_C < $^{-1}$	10	А	
	Continuous Rectified Forward Current @ T_C < \sim	22	А	
I _{F,Max}	Non-Repetitive Peak Forward Surge Current	T _C = 25°C, 10 μs	850	А
		T _C = 150°C, 10 μs	800	А
I _{F,SM}	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	90	А
I _{F,RM}	Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	35	А
P _{TOT}	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	283	W
		T _C = 150°C	47	W
T _J , T _{STG}	Operating and Storage Temperature Range	–55 to +175	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. E_{AS} of 100 mJ is based on starting T_J = 25°C, L = 0.5 mH, I_{AS} = 20 A, V = 150 V.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	0.53	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit	
V _F	Forward Voltage	I _F = 10 A, T _C = 25°C	-	1.45	1.75	1.75 V	
		I _F = 10 A, T _C = 125°C	-	1.7	2.0		
		I _F = 10 A, T _C = 175°C	-	2.0	2.4		
I _R	Reverse Current	V_{R} = 1200 V, T_{C} = 25°C	-	-	200	μΑ	
		V_{R} = 1200 V, T_{C} = 125°C	-	-	300	1	
		V_{R} = 1200 V, T_{C} = 175°C	-	-	400		
Q_{C}	Total Capacitive Charge	V = 800 V	-	62	-	nC	
С	Total Capacitance $V_R = 1 V$, f = 100 kHz		-	612	-	pF	
		V _R = 400 V, f = 100 kHz	-	58	-	1	
		V _R = 800 V, f = 100 kHz	-	47	-	1	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FFSD10120A	FFSD10120A	DPAK	Tape & Reel [†]	13″	N/A	2500 Units

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>

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TYPICAL CHARACTERISTICS

(T_J = 25°C UNLESS OTHERWISE NOTED)

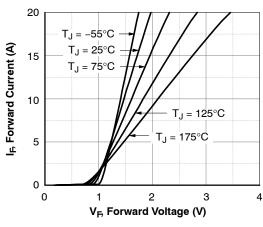
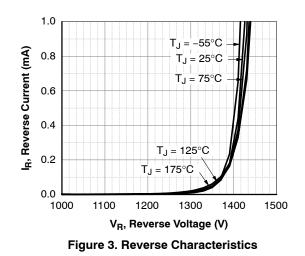
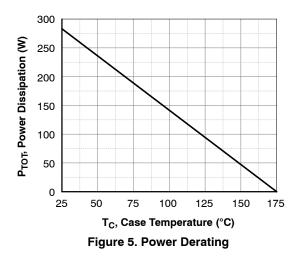


Figure 1. Forward Characteristics





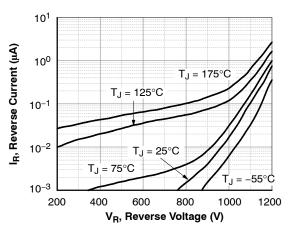


Figure 2. Reverse Characteristics

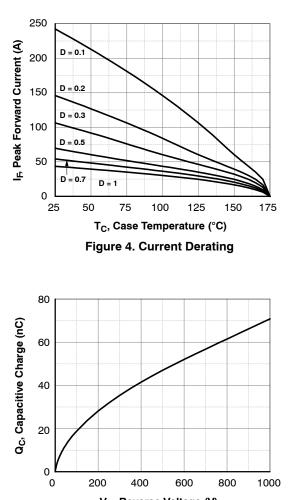




Figure 6. Capacitive Charge vs. Reverse Voltage

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 $\label{eq:typical characteristics} \begin{array}{l} \textbf{Typical characteristics} (\text{Continued}) \\ (T_J = 25^\circ\text{C UNLESS OTHERWISE NOTED}) \end{array}$

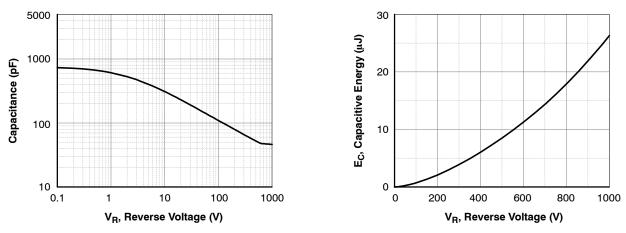
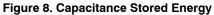
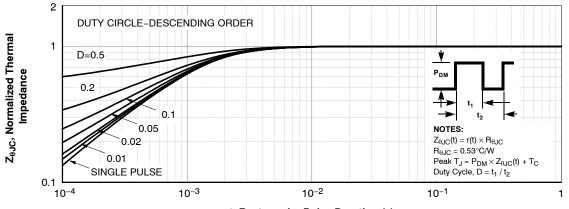


Figure 7. Capacitance vs. Reverse Voltage

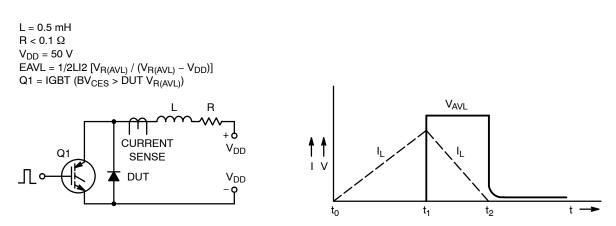




t, Rectangular Pulse Duration (s)

Figure 9. Junction-to-Case Transient Thermal Response Curve

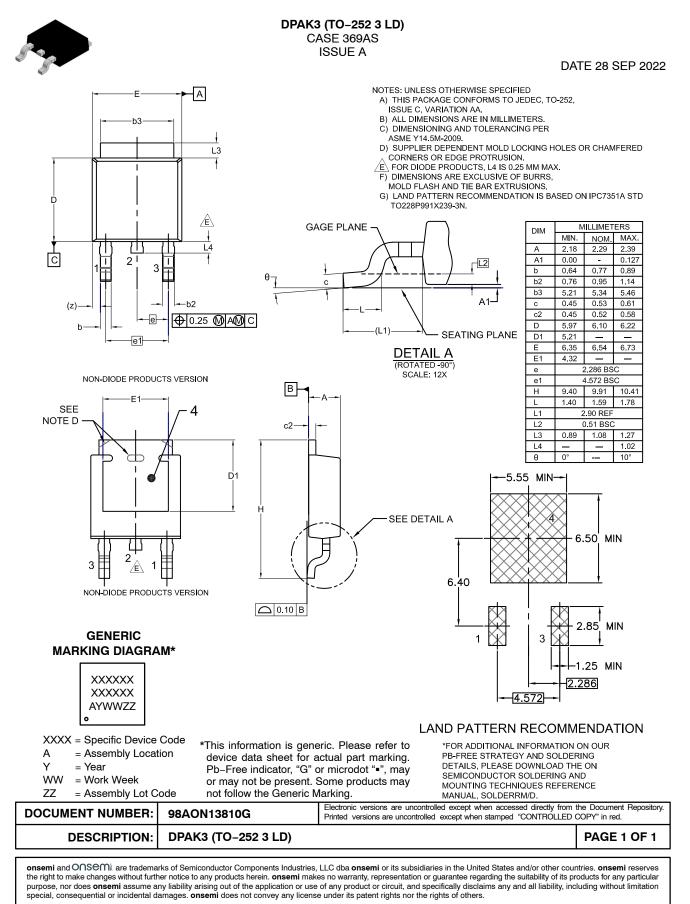
TEST CIRCUIT AND WAVEFORMS





MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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